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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	HCS12
Core Size	16-Bit
Speed	25MHz
Connectivity	EBI/EMI, I ² C, SCI, SPI
Peripherals	POR, PWM, WDT
Number of I/O	60
Program Memory Size	128KB (128K × 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.35V ~ 2.75V
Data Converters	A/D 16x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-QFP
Supplier Device Package	80-QFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s12e128cfue

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Chapter 1 MC9S12E128 Device Overview (MC9S12E128DGV1)

0x0020 – 0x002F DBG (Including BKP) Map 1 of 1 (HCS12 Debug) (continued)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0026	DBGCCH —	R W	Bit 15	14	13	12	11	10	9	Bit 8
0x0027	DBGCCL	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0028	DBGC2 BKPCT0	R W	BKABEN	FULL	BDM	TAGAB	BKCEN	TAGC	RWCEN	RWC
0x0029	DBGC3 BKPCT1	R W	BKAMBH	BKAMBL	BKBMBH	BKBMBL	RWAEN	RWA	RWBEN	RWB
0x002A	DBGCAX BKP0X	R W	PAG	SEL			EXT	CMP		
0x002B	DBGCAH BKP0H	R W	Bit 15	14	13	12	11	10	9	Bit 8
0x002C	DBGCAL BKP0L	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x002D	DBGCBX BKP1X	R W	PAG	SEL			EXT	CMP		
0x002E	DBGCBH BKP1H	R W	Bit 15	14	13	12	11	10	9	Bit 8
0x002F	DBGCBL BKP1L	R W	Bit 7	6	5	4	3	2	1	Bit 0

0x0030 – 0x0031 MMC Map 4 of 4 (HCS12 Module Mapping Control)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0030	PPAGE	R	0	0	PIX5	PIXA	PIX3	PIX2	PIX1	PIX0
	FFAGE	W			TIX5	1 1/14				
0x0031	Reserved	R	0	0	0	0	0	0	0	0
		W								

0x0032 – 0x0033 MEBI Map 3 of 3 (HCS12 Multiplexed External Bus Interface)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0032	PORTK	R W	ECS	XCS	XAB19	XAB18	XAB17	XAB16	XAB15	XAB14
0x0033	DDRK	R W	Bit 7	6	5	4	3	2	1	Bit 0



0x0040 – 0x006F TIM0 (Timer 16 Bit 4 Channels) (Sheet 3 of 4)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0059	TC4 (lo)	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x005A	TC5 (hi)	R W	Bit 15	14	13	12	11	10	9	Bit 8
0x005B	TC5 (lo)	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x005C	TC6 (hi)	R W	Bit 15	14	13	12	11	10	9	Bit 8
0x005D	TC6 (lo)	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x005E	TC7 (hi)	R W	Bit 15	14	13	12	11	10	9	Bit 8
0x005F	TC7 (lo)	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0060	PACTL	R W	0	PAEN	PAMOD	PEDGE	CLK1	CLK0	PAOVI	PAI
0x0061	PAFLG	R W	0	0	0	0	0	0	PAOVF	PAIF
0x0062	PACNT (hi)	R W	Bit 15	14	13	12	11	10	9	Bit 8
0x0063	PACNT (lo)	R W	Bit 7	6	5	4	3	2	1	Bit 0
0x0064	Reserved	R	0	0	0	0	0	0	0	0
0x0065	Reserved	R W	0	0	0	0	0	0	0	0
0x0066	Reserved	R	0	0	0	0	0	0	0	0
0x0067	Reserved	R W	0	0	0	0	0	0	0	0
0x0068	Reserved	R	0	0	0	0	0	0	0	0
0,0000	Recorved	W								
0x0069	Reserved	R W	0	0	0	0	0	0	0	0
0x006A	Reserved	R	0	0	0	0	0	0	0	0
		W	0	0	0	0	0	0	0	0
0x006B	Reserved	W		0	0	0	0	0	0	0



Chapter 1 MC9S12E128 Device Overview (MC9S12E128DGV1)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00B0-	Peserved	R	0	0	0	0	0	0	0	0
0x00C7	Reserveu	W								
0x00C8 -	- 0x00CF	SCI	0 (Async	hronous	Serial Ir	nterface)				
Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00C8	SCIBDH	R W	IREN	TNP1	TNP0	SBR12	SBR11	SBR10	SBR9	SBR8
0x00C9	SCIBDL	R W	SBR7	SBR6	SBR5	SBR4	SBR3	SBR2	SBR1	SBR0
0x00CA	SCICR1	R W	LOOPS	SCISWAI	RSRC	М	WAKE	ILT	PE	PT
0x00CB	SCICR2	R W	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
0x00000	SCISR1	R	TDRE	TC	RDRF	IDLE	OR	NF	FE	PF
0,0000	00101(1	W								
0x00CD	SCISR2	R	0	0	0			BRK13		RAF
0,0000	CONTRE	W					104 02	Bratto		
0x00CE	SCIDRH	R	R8	Т8	0	0	0	0	0	0
CAUCOL	SOIDINI	W								
0x00CF	SCIDRI	R	R7	R6	R5	R4	R3	R2	R1	R0
	SOIDILE	W	T7	T6	T5	T4	T3	T2	T1	Т0

0x00B0 – 0x00C7 Reserved

¹ TXPOL and RXPOL bits are available in version V04 of SCI

0x00D0 – 0x00D7 SCI1 (Asynchronous Serial Interface)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00D0	SCIBDH	R W	IREN	TNP1	TNP0	SBR12	SBR11	SBR10	SBR9	SBR8
0x00D1	SCIBDL	R W	SBR7	SBR6	SBR5	SBR4	SBR3	SBR2	SBR1	SBR0
0x00D2	SCICR1	R W	LOOPS	SCISWAI	RSRC	Μ	WAKE	ILT	PE	PT
0x00D3	SCICR2	R W	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
	SCISP1	R	TDRE	TC	RDRF	IDLE	OR	NF	FE	PF
0,0004	0010101	W								



Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0270	PTAD(H)	R W	PTAD15	PTAD14	PTAD13	PTAD12	PTAD11	PTAD10	PTAD9	PTAD8
0x0271	PTAD(L)	R W	PTAD7	PTAD6	PTAD5	PTAD4	PTAD3	PTAD2	PTAD1	PTAD0
0x0272	PTIAD(H)	R	PTIAD15	PTIAD14	PTIAD13	PTIAD12	PTIAD11	PTIAD10	PTIAD9	PTIAD8
0/10212		W								
0x0273	PTIAD(L)	R	PTIAD7	PTIAD6	PTIAD5	PTIAD4	PTIAD3	PTIAD2	PTIAD1	PTIAD0
		W								
0x0274	DDRAD(H)	R W	DDRAD15	DDRAD14	DDRAD13	DDRAD12	DDRAD11	DDRAD10	DDRAD9	DDRAD8
0x0275	DDRAD(L)	R W	DDRAD7	DDRAD6	DDRAD5	DDRAD4	DDRAD3	DDRAD2	DDRAD1	DDRAD0
0x0276	RDRAD(H)	R W	RDRAD15	RDRAD14	RDRAD13	RDRAD12	RDRAD11	RDRAD10	RDRAD9	RDRAD8
0x0277	RDRAD(L)	R W	RDRAD7	RDRAD6	RDRAD5	RDRAD4	RDRAD3	RDRAD2	RDRAD1	RDRAD0
0x0278	PERAD(H)	R W	PERAD15	PERAD14	PERAD13	PERAD12	PERAD11	PERAD10	PERAD9	PERAD8
0x0279	PERAD(L)	R W	PERAD7	PERAD6	PERAD5	PERAD4	PERAD3	PERAD2	PERAD1	PERAD0
0x027A	PPSAD(H)	R W	PPSAD15	PPSAD14	PPSAD13	PPSAD12	PPSAD11	PPSAD10	PPSAD9	PPSAD8
0x027B	PPSAD(L)	R W	PPSAD7	PPSAD6	PPSAD5	PPSAD4	PPSAD3	PPSAD2	PPSAD1	PPSAD0
0x027C	PIEAD(H)	R W	PIEAD15	PIEAD14	PIEAD13	PIEAD12	PIEAD11	PIEAD10	PIEAD9	PIEAD8
0x027D	PIEAD(L)	R W	PIEAD7	PIEAD6	PIEAD5	PIEAD4	PIEAD3	PIEAD2	PIEAD1	PIEAD0
0x027E	PIFAD(H)	R W	PIFAD15	PIFAD14	PIFAD13	PIFAD12	PIFAD11	PIFAD10	PIFAD9	PIFAD8
0x027F	PIFAD(L)	R W	PIFAD7	PIFAD6	PIFAD5	PIFAD4	PIFAD3	PIFAD2	PIFAD1	PIFAD0

0x0240 – 0x027F PIM (Port Interface Module) (Sheet 4 of 4)

0x0280 – 0x03FF Reserved Space

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0280– 0x2FF	Reserved	R	0	0	0	0	0	0	0	0
		W								
0x0300-	Unimplemented	R	0	0	0	0	0	0	0	0
0x03FF		W								



Chapter 1 MC9S12E128 Device Overview (MC9S12E128DGV1)

1.7 Security

The device will make available a security feature preventing the unauthorized read and write of the memory contents. This feature allows:

- Protection of the contents of FLASH,
- Operation in single-chip mode,
- Operation from external memory with internal FLASH disabled.

The user must be reminded that part of the security must lie with the user's code. An extreme example would be user's code that dumps the contents of the internal program. This code would defeat the purpose of security. At the same time the user may also wish to put a back door in the user's program. An example of this is the user downloads a key through the SCI which allows access to a programming routine that updates parameters.

1.7.1 Securing the Microcontroller

Once the user has programmed the FLASH, the part can be secured by programming the security bits located in the FLASH module. These non-volatile bits will keep the part secured through resetting the part and through powering down the part.

The security byte resides in a portion of the Flash array.

Check the Flash block description chapter for more details on the security configuration.

1.7.2 Operation of the Secured Microcontroller

1.7.2.1 Normal Single Chip Mode

This will be the most common usage of the secured part. Everything will appear the same as if the part was not secured with the exception of BDM operation. The BDM operation will be blocked.

1.7.2.2 Executing from External Memory

The user may wish to execute from external space with a secured microcontroller. This is accomplished by resetting directly into expanded mode. The internal FLASH will be disabled. BDM operations will be blocked.

1.7.3 Unsecuring the Microcontroller

In order to unsecure the microcontroller, the internal FLASH must be erased. This can be done through an external program in expanded mode.

Once the user has erased the FLASH, the part can be reset into special single chip mode. This invokes a program that verifies the erasure of the internal FLASH. Once this program completes, the user can erase and program the FLASH security bits to the unsecured state. This is generally done through the BDM, but the user could also change to expanded mode (by writing the mode bits through the BDM) and jumping to



Chapter 1 MC9S12E128 Device Overview (MC9S12E128DGV1)

1.9.2.2 Effects of Reset

When a reset occurs, MCU registers and control bits are changed to known start-up states. Refer to the respective module block description chapters for register reset states. Refer to the HCS12 MEBI block description chapter for mode dependent pin configuration of port A, B and E out of reset.

Refer to the PIM block description chapter for reset configurations of all peripheral module ports.

Refer to Table 1-1 for locations of the memories depending on the operating mode after reset.

The RAM array is not automatically initialized out of reset.



Chapter 3 Port Integration Module (PIM9E128V1)

3.1.2 Block Diagram

Figure 3-1 is a block diagram of the PIM9E128V1.



Figure 3-1. PIM9E128V1 Block Diagram



Chapter 3 Port Integration Module (PIM9E128V1)

3.3.7.3 Port U Data Direction Register (DDRU)



Read: Anytime. Write: Anytime.

This register configures port pins PU[7:0] as either input or output.

If a pulse width modulator channel is enabled, the associated pin is forced to be an output and the associated Data Direction Register bit has no effect. If the associated pulse width modulator channel is disabled, the corresponding DDRUx bit reverts to control the I/O direction of the associated pin.

If the TIM2 module is enabled, each port pin configured for output compare is forced to be an output and the associated Data Direction Register bit has no effect. If the associated timer output compare is disabled, the corresponding DDRUx bit reverts to control the I/O direction of the associated pin.

If the TIM2 module is enabled, each port pin configured as an input capture has the corresponding DDRUx bit controlling the I/O direction of the associated pin.

When both a timer function and a PWM function are enabled on the same pin, the MODRR register determines which function has control of the pin

3	
	S

Field	Description
7:0 DDRU[7:0]	Data Direction Port U0Associated pin is configured as input.1Associated pin is configured as output.



Chapter 8 Serial Communication Interface (SCIV3)

8.2 External Signal Description

The SCI module has a total of two external pins.

8.2.1 TXD — SCI Transmit Pin

The TXD pin transmits SCI (standard or infrared) data. It will idle high in either mode and is high impedance anytime the transmitter is disabled.

8.2.2 RXD — SCI Receive Pin

The RXD pin receives SCI (standard or infrared) data. An idle line is detected as a line high. This input is ignored when the receiver is disabled and should be terminated to a known voltage.

8.3 Memory Map and Register Definition

This subsection provides a detailed description of all the SCI registers.

8.3.1 Module Memory Map

The memory map for the SCI module is given in Figure 8-2. The address listed for each register is the address offset. The total address for each register is the sum of the base address for the SCI module and the address offset for each register.

8.3.2 Register Descriptions

This subsection consists of register descriptions in address order. Each description includes a standard register diagram with an associated figure number. Writes to reserved register locations do not have any effect and reads of these locations return a 0. Details of register bit and field function follow the register diagrams, in bit order.

Register Name	Bit 7	6	5	4	3	2	1	Bit 0
SCIBDH F	R IREN	TNP1	TNP0	SBR12	SBR11	SBR10	SBR9	SBR8
SCIBDL F	SBR7	SBR6	SBR5	SBR4	SBR3	SBR2	SBR1	SBR0
SCICR1 F	LOOPS	SCISWAI	RSRC	М	WAKE	ILT	PE	PT
		= Unimple	mented or R	eserved				





Chapter 11 Pulse Width Modulator with Fault Protection (PMF15B6CV2)

11.3.2.24 PMF Deadtime A Register (PMFDTMA)

Module Base + 0x0026



Read anytime. This register cannot be modified after the WP bit is set.

Table 11-31	. PMFDTMA	Field	Descriptions
-------------	-----------	-------	--------------

Field	Description
11–0 PMFDTMA	PMF Deadtime A Bits — The 12-bit value written to this register is the number of PWM clock cycles in complementary channel operation. A reset sets the PWM deadtime register to a default value of 0x0FFF, selecting a deadtime of 256-PWM clock cycles minus one bus clock cycle. Note: Deadtime is affected by changes to the prescaler value. The deadtime duration is determined as follows: $DT = P \times PMFDTMA - 1$, where DT is deadtime, P is the prescaler value, PMFDTMA is the programmed value of dead time. For example: if the prescaler is programmed for a divide-by-two and the PMFDTMA is set to five, then P = 2 and the deadtime value is equal to $DT = 2 \times 5 - 1 = 9$ IPbus clock cycles. A special case exists when the P = 1, then DT = PMFDTMA.



Chapter 11 Pulse Width Modulator with Fault Protection (PMF15B6CV2)

11.4.8.2 Automatic Fault Clearing

Setting a fault mode bit, FMODEx, configures faults from the FAULTx pin for automatic clearing.

When FMODEx is set, disabled PWM pins are enabled when the FAULTx pin returns to logic zero and a new PWM half cycle begins. See Figure 11-76. Clearing the FFLAGx flag does not affect disabled PWM pins when FMODEx is set.



Figure 11-76. Automatic Fault Clearing

11.4.8.3 Manual Fault Clearing

Clearing a fault mode bit, FMODEx, configures faults from the FAULTx pin for manual clearing:

- PWM pins disabled by the FAULT0 pin or the FAULT2 pin are enabled by clearing the corresponding FFLAGx flag. The time at which the PWM pins are enabled depends on the corresponding QSMPx bit setting. If QSMPx = 00, the PWM pins are enabled on the next IP bus cycle when the logic level detected by the filter at the fault pin is logic zero. If QSMPx = 01,10 or 11, the PWMs are enabled when the next PWM half cycle begins regardless of the state of the logic level detected by the filter at the fault. See Figure 11-77 and Figure 11-78.
- PWM pins disabled by the FAULT1 pin or the FAULT3 pin are enabled when
 - Software clears the corresponding FFLAGx flag
 - The filter detects a logic zero on the fault pin at the start of the next PWM half cycle boundary. See Figure 11-79.



Figure 11-77. Manual Fault Clearing (Faults 0 & 2) — QSMP = 00



12.1.3 Block Diagram



Figure 12-1. PWM8B6CV1 Block Diagram

12.2 External Signal Description

The PWM8B6CV1 module has a total of six external pins.

12.2.1 PWM5 — Pulse Width Modulator Channel 5 Pin

This pin serves as waveform output of PWM channel 5 and as an input for the emergency shutdown feature.

12.2.2 PWM4 — Pulse Width Modulator Channel 4 Pin

This pin serves as waveform output of PWM channel 4.

12.2.3 PWM3 — Pulse Width Modulator Channel 3 Pin

This pin serves as waveform output of PWM channel 3.



Chapter 12 Pulse-Width Modulator (PWM8B6CV1)



Read: anytime

Write: anytime (any value written causes PWM counter to be reset to 0x0000).

12.3.2.13 PWM Channel Period Registers (PWMPERx)

There is a dedicated period register for each channel. The value in this register determines the period of the associated PWM channel.

The period registers for each channel are double buffered so that if they change while the channel is enabled, the change will NOT take effect until one of the following occurs:

- The effective period ends
- The counter is written (counter resets to 0x0000)
- The channel is disabled

In this way, the output of the PWM will always be either the old waveform or the new waveform, not some variation in between. If the channel is not enabled, then writes to the period register will go directly to the latches as well as the buffer.

NOTE

Reads of this register return the most recent value written. Reads do not necessarily return the value of the currently active period due to the double buffering scheme.

Reference Section 12.4.2.3, "PWM Period and Duty," for more information.



Chapter 12 Pulse-Width Modulator (PWM8B6CV1)





Write: Anytime for output compare function.Writes to these registers have no meaning or effect during input capture. All timer input capture/output compare registers are reset to 0x0000.

NOTE

Read/Write access in byte mode for high byte should takes place before low byte otherwise it will give a different result.

13.3.2.15 16-Bit Pulse Accumulator Control Register (PACTL)



Figure 13-22. 16-Bit Pulse Accumulator Control Register (PACTL)

When PAEN is set, the PACT is enabled. The PACT shares the input pin with IOC7.

Read: Any time

Write: Any time

Table 13-17. PACTL Field Descriptions

Field	Description
6 PAEN	 Pulse Accumulator System Enable — PAEN is independent from TEN. With timer disabled, the pulse accumulator can function unless pulse accumulator is disabled. 0 16-Bit Pulse Accumulator system disabled. 1 Pulse Accumulator system enabled.
5 PAMOD	 Pulse Accumulator Mode — This bit is active only when the Pulse Accumulator is enabled (PAEN = 1). See Table 13-18. 0 Event counter mode. 1 Gated time accumulation mode.
4 PEDGE	 Pulse Accumulator Edge Control — This bit is active only when the Pulse Accumulator is enabled (PAEN = 1). For PAMOD bit = 0 (event counter mode). See Table 13-18. Falling edges on IOC7 pin cause the count to be incremented. Rising edges on IOC7 pin cause the count to be incremented. For PAMOD bit = 1 (gated time accumulation mode). IOC7 input pin high enables M (bus clock) divided by 64 clock to Pulse Accumulator and the trailing falling edge on IOC7 sets the PAIF flag. IOC7 input pin low enables M (bus clock) divided by 64 clock to Pulse Accumulator and the trailing rising edge on IOC7 sets the PAIF flag.
3:2 CLK[1:0]	Clock Select Bits — Refer to Table 13-19.



The minimum pulse width for the PAI input is greater than two bus clocks.

13.4.5 Event Counter Mode

Clearing the PAMOD bit configures the PACNT for event counter operation. An active edge on the IOC7 pin increments the pulse accumulator counter. The PEDGE bit selects falling edges or rising edges to increment the count.

NOTE

The PACNT input and timer channel 7 use the same pin IOC7. To use the IOC7, disconnect it from the output logic by clearing the channel 7 output mode and output level bits, OM7 and OL7. Also clear the channel 7 output compare 7 mask bit, OC7M7.

The Pulse Accumulator counter register reflect the number of active input edges on the PACNT input pin since the last reset.

The PAOVF bit is set when the accumulator rolls over from 0xFFFF to 0x0000. The pulse accumulator overflow interrupt enable bit, PAOVI, enables the PAOVF flag to generate interrupt requests.

NOTE

The pulse accumulator counter can operate in event counter mode even when the timer enable bit, TEN, is clear.

13.4.6 Gated Time Accumulation Mode

Setting the PAMOD bit configures the pulse accumulator for gated time accumulation operation. An active level on the PACNT input pin enables a divided-by-64 clock to drive the pulse accumulator. The PEDGE bit selects low levels or high levels to enable the divided-by-64 clock.

The trailing edge of the active level at the IOC7 pin sets the PAIF. The PAI bit enables the PAIF flag to generate interrupt requests.

The pulse accumulator counter register reflect the number of pulses from the divided-by-64 clock since the last reset.

NOTE

The timer prescaler generates the divided-by-64 clock. If the timer is not active, there is no divided-by-64 clock.

13.5 Resets

The reset state of each individual bit is listed within Section 13.3, "Memory Map and Register Definition" which details the registers and their bit fields.



Chapter 15 Background Debug Module (BDMV4)

15.1 Introduction

This section describes the functionality of the background debug module (BDM) sub-block of the HCS12 core platform.

A block diagram of the BDM is shown in Figure 15-1.



Figure 15-1. BDM Block Diagram

The background debug module (BDM) sub-block is a single-wire, background debug system implemented in on-chip hardware for minimal CPU intervention. All interfacing with the BDM is done via the BKGD pin.

BDMV4 has enhanced capability for maintaining synchronization between the target and host while allowing more flexibility in clock rates. This includes a sync signal to show the clock rate and a handshake signal to indicate when an operation is complete. The system is backwards compatible with older external interfaces.

15.1.1 Features

- Single-wire communication with host development system
- BDMV4 (and BDM2): Enhanced capability for allowing more flexibility in clock rates
- BDMV4: SYNC command to determine communication rate
- BDMV4: GO_UNTIL command
- BDMV4: Hardware handshake protocol to increase the performance of the serial communication
- Active out of reset in special single-chip mode



Register Name		Bit 7	6	5	4	3	2	1	Bit 0	
Reserved	R	Х	Х	Х	Х	Х	Х	0	0	
	W									
BDMSTS	R		BDMACT	ENTAG	SDV	TRACE	CLKSW	UNSEC	0	
	W			LINIAG			CLNOW			
Reserved	R	Х	Х	Х	Х	Х	Х	Х	Х	
	W									
Reserved	R	Х	Х	Х	Х	Х	Х	Х	Х	
	w									
Reserved	R	Х	Х	Х	Х	Х	Х	Х	Х	
	w									
Reserved	R	Х	Х	Х	Х	Х	Х	Х	Х	
	W									
BDMCCR	R	CCR7	CCR6	CCR5	CCR4	CCR3	CCR2	CCR1	CCR0	
	w									
BDMINR	R	0	REG14	REG13	REG12	REG11	0	0	0	
	w									
Reserved	R	0	0	0	0	0	0	0	0	
	W									
Reserved	R	0	0	0	0	0	0	0	0	
	w									
Reserved	R	Х	Х	Х	Х	Х	Х	Х	Х	
	W									
Reserved	R	Х	Х	Х	Х	Х	Х	Х	Х	
	w									
			= Unimplemented, Reserved				= Implemented (do not alter)			
		Х	= Indeterminate			0	= Always read zero			
Figure 15.2 BDM Bogister Summery										

Register Descriptions 15.3.2

Figure 15-2. BDM Register Summary



Chapter 16 Debug Module (DBGV1)

16.3 Memory Map and Register Definition

A summary of the registers associated with the DBG sub-block is shown in Figure 16-3. Detailed descriptions of the registers and bits are given in the subsections that follow.

16.3.1 Module Memory Map

Address Offset	Use			
	Debug Control Register (DBGC1)	R/W		
	Debug Status and Control Register (DBGSC)	R/W		
	Debug Trace Buffer Register High (DBGTBH)	R		
	Debug Trace Buffer Register Low (DBGTBL)	R		
4	Debug Count Register (DBGCNT)	R		
5	Debug Comparator C Extended Register (DBGCCX)	R/W		
6	Debug Comparator C Register High (DBGCCH)	R/W		
	Debug Comparator C Register Low (DBGCCL)	R/W		
8	Debug Control Register 2 (DBGC2) / (BKPCT0)	R/W		
9	Debug Control Register 3 (DBGC3) / (BKPCT1)	R/W		
А	Debug Comparator A Extended Register (DBGCAX) / (/BKP0X)	R/W		
В	Debug Comparator A Register High (DBGCAH) / (BKP0H)	R/W		
	Debug Comparator A Register Low (DBGCAL) / (BKP0L)	R/W		
	Debug Comparator B Extended Register (DBGCBX) / (BKP1X)	R/W		
E	Debug Comparator B Register High (DBGCBH) / (BKP1H)	R/W		
F	Debug Comparator B Register Low (DBGCBL) / (BKP1L)	R/W		

Table 16-2. DBGV1 Memory Map

16.3.2 Register Descriptions

This section consists of the DBG register descriptions in address order. Most of the register bits can be written to in either BKP or DBG mode, although they may not have any effect in one of the modes. However, the only bits in the DBG module that can be written while the debugger is armed (ARM = 1) are DBGEN and ARM





Conditions are VDDX=3.3V+/-10%, Junction Temperature -40°C to +140°C, C _{LOAD} = 50pF								
Num	С	Rating	Symbol	Min	Тур	Max	Unit	
1	Р	Frequency of operation (E-clock)	f _o	0		16.0	MHz	
2	Р	Cycle time	t _{cyc}	62.5	_	_	ns	
3	D	Pulse width, E low	PW_{EL}	30	_	_	ns	
4	D	Pulse width, E high ¹	PW_{EH}	30	_	_	ns	
5	D	Address delay time	t _{AD}	—	_	16	ns	
6	D	Address valid time to E rise (PW _{EL} -t _{AD})	t _{AV}	16	_	_	ns	
7	D	Muxed address hold time	t _{MAH}	2	—	_	ns	
8	D	Address hold to data valid	t _{AHDS}	7	—	—	ns	
9	D	Data hold to address	t _{DHA}	2	_	_	ns	
10	D	Read data setup time	t _{DSR}	15	—	_	ns	
11	D	Read data hold time	t _{DHR}	0	—	—	ns	
12	D	Write data delay time	t _{DDW}	—	_	15	ns	
13	D	Write data hold time	t _{DHW}	2	_	_	ns	
14	D	Write data setup time ¹ (PW _{EH} -t _{DDW})	t _{DSW}	15	_	_	ns	
15	D	Address access time ¹ (t _{cyc} -t _{AD} -t _{DSR})	t _{ACCA}	29	_	_	ns	
16	D	E high access time ¹ (PW _{EH} –t _{DSR})	t _{ACCE}	15	_	_	ns	
17	D	Non-multiplexed address delay time	t _{NAD}	—	_	14	ns	
18	D	Non-muxed address valid to E rise (PW_{EL} -t _{NAD})	t _{NAV}	16	_	_	ns	
19	D	Non-multiplexed address hold time	t _{NAH}	2	_	_	ns	
20	D	Chip select delay time	t _{CSD}	—	—	25	ns	
21	D	Chip select access time ¹ (t _{cyc} -t _{CSD} -t _{DSR})	t _{ACCS}	22.5	_	_	ns	
22	D	Chip select hold time	t _{CSH}	2	_	_	ns	
23	D	Chip select negated time	t _{CSN}	8	_	_	ns	
24	D	Read/write delay time	t _{RWD}	—	_	14	ns	
25	D	Read/write valid time to E rise (PW _{EL} -t _{RWD})	t _{RWV}	16	—	—	ns	
26	D	Read/write hold time	t _{RWH}	2	_	_	ns	
27	D	Low strobe delay time	t _{LSD}	—	_	14	ns	
28	D	Low strobe valid time to E rise (PW_{EL} -t _{LSD})	t _{LSV}	16	_	_	ns	
29	D	Low strobe hold time	t _{LSH}	2	_	_	ns	
30	D	NOACC strobe delay time	t _{NOD}	—	_	14	ns	
31	D	NOACC valid time to E rise (PW _{EL} -t _{NOD})	t _{NOV}	16	_	_	ns	
32	D	NOACC hold time	t _{NOH}	2	_	_	ns	
33	D	IPIPO[1:0] delay time	t _{P0D}	2	_	14	ns	
34	D	IPIPO[1:0] valid time to E rise (PW _{EL} -t _{P0D})	t _{P0V}	16	—	—	ns	
35	D	IPIPO[1:0] delay time ¹ (PW _{EH} -t _{P1V})	t _{P1D}	2	—	25	ns	
36	D	IPIPO[1:0] valid time to E fall	t _{P1V}	11			ns	

Table A-27. Expanded Bus Timing Characteristics (3.3V Range)

 $^1\,$ Affected by clock stretch: add N x t_{cyc} where N=0,1,2 or 3, depending on the number of clock stretches.